

N-CHANNEL 30V - 0.020 Ω - 6A TSSOP8 2.5V-DRIVE STripFETTM II POWER MOSFET

TYPE	V _{DSS}	R _{DS(on)}	I _D
STC6NF30V	30 V	< 0.025 Ω (@ 4.5 V) < 0.030 Ω (@ 2.5 V)	6 A

- TYPICAL R_{DS}(on) = 0.020 Ω @ 4.5 V
- TYPICAL $R_{DS}(on) = 0.025 \Omega$ @ 2.5 V
- ULTRA LOW THRESHOLD GATE DRIVE (2.5 V)
- STANDARD OUTLINE FOR EASY AUTOMATED SURFACE MOUNT ASSEMBLY
- DOUBLE DICE IN COMMON DRAIN CONFIGURATION

DESCRIPTION

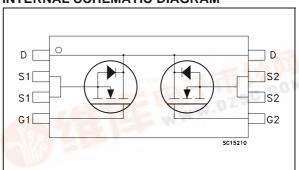
This Power MOSFET is the latest development of STMicroelectronis unique "Single Feature SizeTM" strip-based process. The resulting transistor shows extremely high packing density for low on-resistance.

APPLICATIONS

- DC MOTOR DRIVE
- DC-DC CONVERTERS
- BATTERY SAFETY UNIT FOR NOMADIC EQUIPMENT
- POWER MANAGEMENT IN PORTABLE/DESKTOP PCs



INTERNAL SCHEMATIC DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source Voltage (V _{GS} = 0)	30	V
V _{DGR}	Drain-gate Voltage ($R_{GS} = 20 \text{ k}\Omega$)	30	V
V _{GS}	Gate- source Voltage	± 12	V
ID	Drain Current (continuous) at T _C = 25°C	6	А
ID	Drain Current (continuous) at T _C = 100°C	3.8	А
I _{DM} (●)	Drain Current (pulsed)	24	А
P _{tot}	Total Dissipation at T _C = 25°C	1.5	W

(•) Pulse width limited by safe operating area.



THERMAL DATA

Rthj-pcb Rthj-pcb Tj	Thermal Resistance Junction-PCB (**) Thermal Resistance Junction-PCB (*) Operating Junction Temperature	Max Max	100 83.5 -55 to 150	°C/W °C/W °C/W
T _{stg}	Storage temperature		-55 to 150	°C

^(*) When Mounted on FR-4 board with 1 inch² pad, 2 oz of Cu and $t \leq 10 \mbox{ sec}$

ELECTRICAL CHARACTERISTICS ($T_j = 25$ °C unless otherwise specified)

OFF

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0$	30			V
I _{DSS}	Zero Gate Voltage Drain Current (V _{GS} = 0)	V_{DS} = Max Rating V_{DS} = Max Rating T_{C} = 125°C			1 10	μA μA
IGSS	Gate-body Leakage Current (V _{DS} = 0)	V _{GS} = ± 12 V			±100	nA

ON (*)

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$	I _D = 250 μA	0.6			V
R _{DS(on)}	Static Drain-source On Resistance	V _{GS} = 4.5 V V _{GS} = 2.5 V	I _D = 3 A I _D = 3 A		0.020 0.025	0.025 0.030	Ω Ω

DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
g _{fs} (*)	Forward Transconductance	$V_{DS} = 10 \text{ V}$ $I_{D} = 6 \text{ A}$		18		S
C _{iss} C _{oss} C _{rss}	Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{DS} = 25V f = 1 MHz, V_{GS} = 0$		800 180 32		pF pF pF

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^(**) When Mounted on minimum recommended footprint

ELECTRICAL CHARACTERISTICS (continued)

SWITCHING ON

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r	Turn-on Delay Time Rise Time	$\begin{array}{ccc} V_{DD} = 15 \text{ V} & I_D = 3 \text{ A} \\ R_G = 4.7 \Omega & V_{GS} = 2.5 \text{ V} \\ \text{(Resistive Load, Figure 1)} \end{array}$		20 25		ns ns
Q _g Q _{gs} Q _{gd}	Total Gate Charge Gate-Source Charge Gate-Drain Charge	V _{DD} = 15V I _D = 6A V _{GS} =2.5V (see test circuit, Figure 2)		6.8 2.0 3.4	9	nC nC nC

SWITCHING OFF

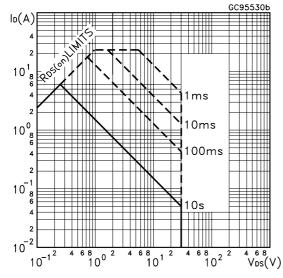
Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
t _{d(off)}	Turn-off Delay Time Fall Time	V_{DD} = 15 V R_G = 4.7 Ω , (Resistive Load	$I_D = 3 A$ $V_{GS} = 2.5 V$ d, Figure 1)		32 13		ns ns

SOURCE DRAIN DIODE

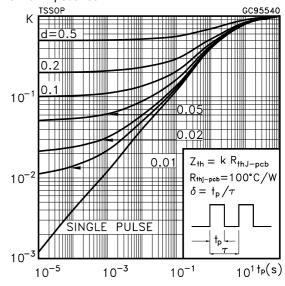
Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
I _{SD}	Source-drain Current Source-drain Current (pulsed)					6 24	A A
V _{SD} (*)	Forward On Voltage	I _{SD} = 6 A	V _{GS} = 0			1.2	V
t _{rr} Q _{rr} I _{RRM}	Reverse Recovery Time Reverse Recovery Charge Reverse Recovery Current	I _{SD} = 6 A V _{DD} = 15 V (see test circu	di/dt = $100A/\mu s$ $T_j = 150^{\circ}C$ it, Figure 3)		25 21 1.7		ns nC A

^(*)Pulsed: Pulse duration = 300 μs, duty cycle 1.5 %.

Safe Operating Area.

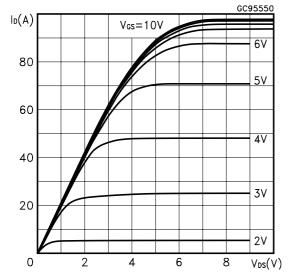


Thermal Impedance.

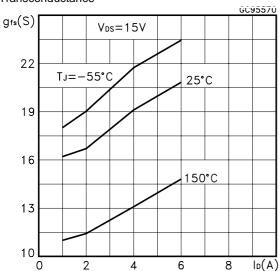


^(•)Pulse width limited by safe operating area.

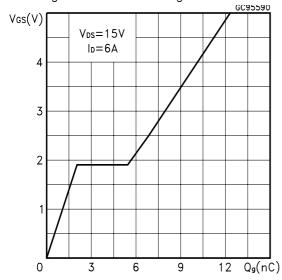
Output Characteristics



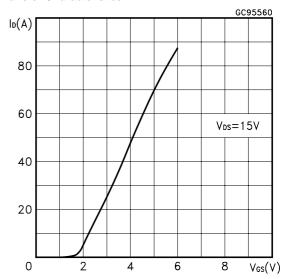
Transconductance



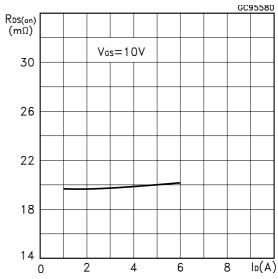
Gate Charge vs Gate-source Voltage



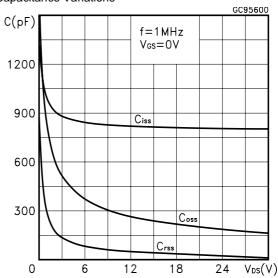
Transfer Characteristics



Static Drain-source On Resistance

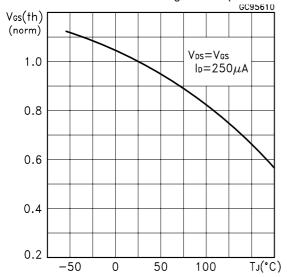


Capacitance Variations

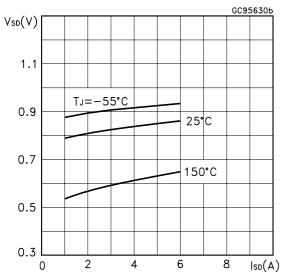


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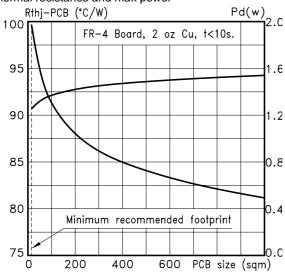
Normalized Gate Threshold Voltage vs Temperature



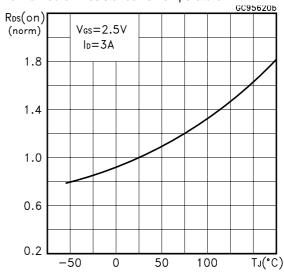
Source-drain Diode Forward Characteristics



Thermal resistance and max power



Normalized on Resistance vs Temperature



Normalized Breakdown Voltage Temperature

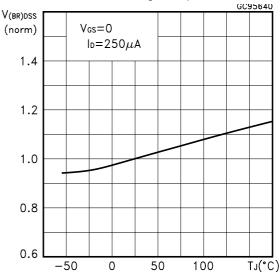


Fig. 1: Switching Times Test Circuits For Resistive Load

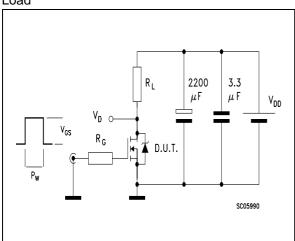


Fig. 2: Gate Charge test Circuit

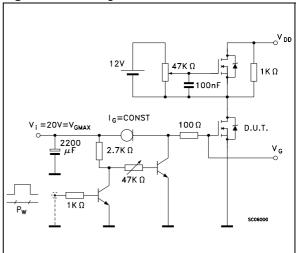
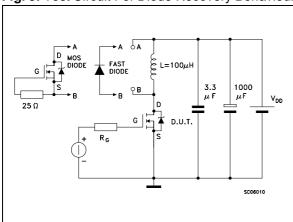


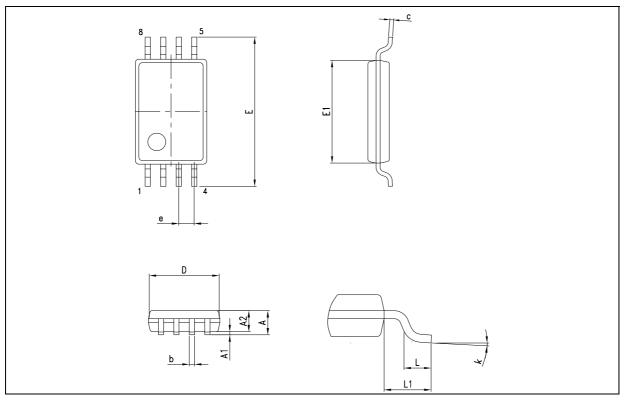
Fig. 3: Test Circuit For Diode Recovery Behaviour



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TSSOP8 MECHANICAL DATA

DIM		mm.				
DIM.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
Α	1.05		1.20	0.041		0.047
A1	0.05		0.15	0.002		0.006
A2	0.80		1.05	0.032		0.041
b	0.19		0.30	0.008		0.012
С	0.090		0.20	0.003		0.007
D	2.90		3.10	0.114		0.122
Е	6.20		6.60	0.240		0.260
E1	4.30		4.50	0.170		0.177
е		0.65			0.025	
L	0.45		0.75	0.018		0.030
L1		1.00			0.039	
k	00		80	0.192		0.208



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